



BAS19 / BAS20 / BAS21

SURFACE MOUNT FAST SWITCHING DIODE

Features

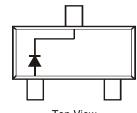
- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automated Insertion
- For General-Purpose Switching Applications
- High Conductance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DIODES[™] BAS20Q and DIODES[™] BAS21Q are suitable for automotive applications requiring specific change control; these parts are AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities. <u>https://www.diodes.com/quality/productdefinitions/</u>

Mechanical Data

- Package: SOT23
- Package Material: Molded Plastic.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead-Free Plating (Matte Tin Finish Annealed over Alloy 42 Leadframe). (3)
- Polarity: See Diagram
- Weight: 0.008 grams (Approximate)



Top View



Top View Internal Schematic

Ordering Information (Note 4)

Part Number	Package	Packing		
Fait Number	Fackage	Quantity	Carrier	
BAS19-7-F	SOT23	3,000	Tape & Reel	
BAS20-7-F	SOT23	3,000	Tape & Reel	
BAS20-13-F	SOT23	10,000	Tape & Reel	
BAS20Q-13-F	SOT23	10,000	Tape & Reel	
BAS21-7-F	SOT23	3,000	Tape & Reel	
BAS21Q-7-F	SOT23	3,000	Tape & Reel	
BAS21-13-F	SOT23	10,000	Tape & Reel	
BAS21Q-13-F	SOT23	10,000	Tape & Reel	

Notes:

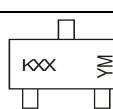
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen, Antimony and Beryllium-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl), <1000ppm antimony compounds and <1000ppm Beryllium.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



KXX = Product Type Marking Code BAS19 Marking: KA8, KT3; KT2 BAS20 Marking: KT2, KT3 BAS21 Marking: KT3 YM = Date Code Marking

Y = Year (ex: K = 2023)

M = Month (ex: 9 = September)

Date Code Key

Year	2000		2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	L		K	L	М	N	0	Р	R	S	Т	U
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@T_A = 25°C, unless otherwise specified.)

Characteristic	Symbol	BAS19	BAS20	BAS21	Unit	
Repetitive Peak Reverse Voltage	V _{RRM}	120	200	250	V	
Working Peak Reverse Voltage DC Blocking Voltage			100	150	200	V
RMS Reverse Voltage	V _{R(RMS)}	71	106	141	V	
Forward Continuous Current (Note 5)	I _{FM}		400		mA	
Average Rectified Output Current (Note 5)	I _O		200		mA	
Non-Repetitive Peak Forward Surge Current $\begin{array}{c} @ t = 1.0 \mu s \\ @ t = 1.0 s \end{array}$		I _{FSM}	2.5 0.5			А
Repetitive Peak Forward Surge Current (Note 5)	I _{FRM}		625		mA	

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	250	mW
Thermal Resistance Junction to Ambient Air (Note 5)	R _{θJA}	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

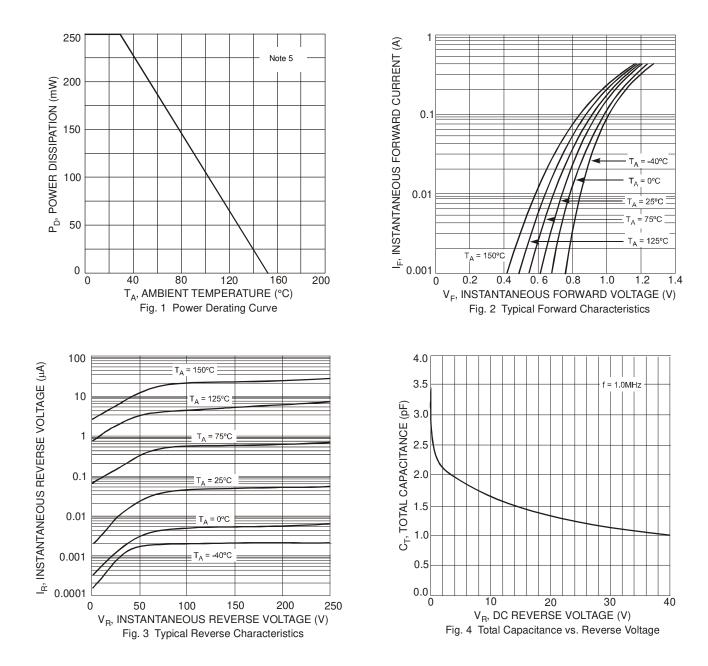
Electrical Characteristics (@T_A = 25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition	
Reverse Breakdown Voltage (Note 6)	BAS19 BAS20 BAS21	V _{(BR)R}	120 200 250	_	v	I _R = 100μΑ
Forward Voltage		VF	_	1.0 1.25	V	I _F = 100mA I _F = 200mA
Reverse Current @ Rated DC Blocking Voltage (Note 6)			_	100 15	nA μA	$T_J = 25^{\circ}C$ $T_J = 100^{\circ}C$
Total Capacitance		CT	_	5.0	pF	V _R = 0, f = 1.0MHz
Reverse Recovery Time			_	50	ns	$\label{eq:lensergy} \begin{split} I_F &= I_R = 30 m A, \\ I_{rr} &= 0.1 \ x \ I_R, \ R_L = 100 \Omega \end{split}$

Notes: 5. Part mounted on FR-4 board with one inch square, 2oz copper pad layout. I_{FM}, I_o are valid provided that terminals are kept at ambient temperature. 6. Short duration pulse test used to minimize self-heating effect.



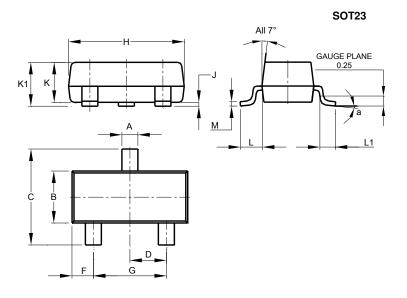
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Package Outline Dimensions

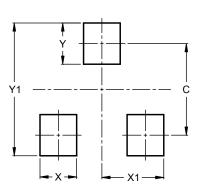
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23							
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
C	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
H	2.80	2.80 3.00					
J	0.013	0.10	0.05				
К	0.890	1.00	0.975				
K1	0.903	1.10	1.025				
L	0.45	0.61	0.55				
L1	0.25	0.55	0.40				
М	0.085	0.150	0.110				
а	0°	8°					
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23

Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9



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